

## APPLICATIONS

- α Test Electrical contacts in BGA, LGA, PGA test sockets and contactors, with  $\geq 0.36\text{mm}$  arrays.
- α Test MCM and hybrid-circuit test fixtures with  $\geq 0.36\text{mm}$  centers.
- α Test Panel testing: *fine-pitch* or high density *pcb* and *semi-flex*, glass, ceramic, and composition panels.
- α Test Wafer Burn-In Testing with  $\geq 0.36\text{mm}$  centers.
- α Test Controlled Impedance test fixtures and sockets for  $>100$  MHz testing.
- α Test Custom sockets, contactors, or fixtures requiring *fine-pitch*, *high-density*, or *wide-bandwidth* contacts from tester to device under test.

## SPECIFICATIONS

minimum spacing:	$\geq 263 \mu\text{m}$ (0.014")
probe diameter:	$305 \mu\text{m}$ (0.012")
spring type:	rectangular helix
spring material:	304 stainless steel
spring length options:	
S300*2300	2,3 mm (0.091")
S300*3800	3,8 mm (0.150")
overall length options:	
S300*2300	3,3 mm (0.120")
S300*3800	5,1 mm (0.200")
spring force options:	30 gm or 100 gm @ 1/2 compliance
spring compliance:	(for 100 gm spring / 30 gm spring)
S300*2300	250 $\mu\text{m}$ / 300 $\mu\text{m}$
S300*3800	600 $\mu\text{m}$ / 700 $\mu\text{m}$
plunger length:	
S300*2300	1,0 mm (0.039")
S300*3800	1,3 mm (0.051")
plunger tip shape options:	sharp, flat, round, crown
plunger diameter:	221 $\mu\text{m}$ (0.0087")
plunger material options:	BeCu +Ni+25 $\mu$ " hard Au Steel +Ni+25 $\mu$ " hard Au
plunger lubricant:	none
input/output end of probe:	304SS tube +Ni+hard Au
probe resistance:	$<30 \text{ m}\Omega$ for $>10^6$ cycles
μHELIX® spring life:	$>10^6$ operations
probe temperature range:	-40 to 150°C
probe current rating:	1½ Amps continuous
Installed pointing accuracy:	drill accuracy $\pm 10 \mu\text{m}$
<b>INSTALLATION NOTES:</b>	
drill size for spring	#80, 343 $\mu\text{m}$ (0.0135")
drill size for plunger	#89, 231 $\mu\text{m}$ (0.0091")

## FEATURES

- P short length
- P small diameter
- P durable spring
- P integral tip
- P no lubricant in probe
- P rectangular helix

## CHARACTERISTIC

- *wide bandwidth*
- low *crosstalk*
- fixture transparency
- *fine-pitch* placement
- millions of operations
- $\mu\text{m}$  pointing accuracy
- reduced contamination
- control of specifications

## BENEFIT

- improves high frequency digital testing
- simplifies mixed signal testing
- low *fixture-contributed* noise
- reduced fixture/program debug time
- *all-points* contact testing
- extended life of *fixture-based* ATE
- reduced fixture life-cycle-cost
- reduced DUT alignment/test time
- extended *low-resistance* operation
- small size, wide range of forces

**ORDERING INFORMATION:**

Contact *AlphaTest* for additional information or to discuss your application.

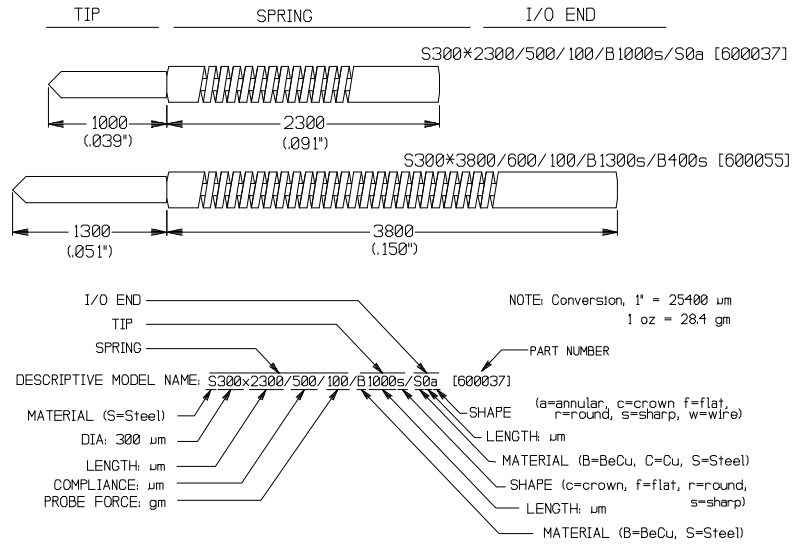
Select the basic parameters (size and force and tip shape)

- Diameter [ ] S300 (see S200, S400, S500 data sheets for smaller probes)
- Length [ ] 2.3mm [ ] 3.8 mm
- Force [ ] 100 gm [ ] 30 gm
- Tip style [ ] sharp [ ] round [ ] flat [ ] crown

and contact *AlphaTest* at 602.545.5518 for part number, price, and delivery quotation.

**DESCRIPTIVE MODEL NUMBER:**

The  $\mu$ HELIX® Test Probe's Descriptive Model Number (DMN) contains most of the critical specifications for S300 Series Test Probes and provides a quick reminder off the size and force specifications.. The probe's six digit part number [600037] uniquely identifies each probes application specifications and manufacturing procedures.



**FIXTURE CONSTRUCTION**

- fine-pitch* applications Refer to application note TN0007 “ $\mu$ HELIX *fine-pitch* fixtures”
- high pin-count* applications Refer to application note TN0008 “ $\mu$ HELIX *high-density* fixtures”
- wide bandwidth* applications Refer to application note **TN0009** “ $\mu$ HELIX *wide-bandwidth* fixtures”
- noise reduction* techniques Refer to application note TN0010 “ $\mu$ HELIX *low-noise* fixtures”
- socket / contactor* constion Refer to application note TN0011 “ $\mu$ HELIX *Sockets/Contactor* construction”